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SN54166, SN54LS166A, SN74166, SN74LS166A PARALLEL-LOAD 8-BIT SHIFT REGISTERS

SN54166, SN54LS166A . . . J OR W PACKAGE

OCTOBER 1976 - REVISED MARCH 1988

- Synchronous Load
- Direct Overriding Clear
- Parallel to Serial Conversion

ТҮРЕ	TYPICAL MAXIMUM CLOCK FREQUENCY	TYPICAL POWER DISSIPATION
'166 'LS166A	35 MHz 35 MHz	360 mW 100 mW
2010011		

description

The '166 and 'LS166A 8-bit shift registers are compatible with most other TTL logic families. All '166 and 'LS166A inputs are buffered to lower the drive requirements to one Series 54/74 or Series 54LS/74LS standard load, respectively. Input clamping diodes minimize switching transients and simplify system design.

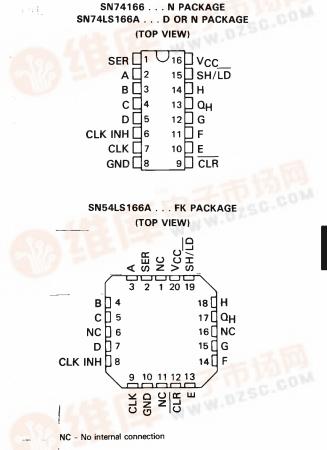
These parallel-in or serial-in, serial-out shift registers have a complexity of 77 equivalent gates on a monolithic chip. They feature gated clock inputs and an overriding clear input. The parallel-in or serial-in modes are established by the shift/load input. When high, this input enables the serial data input and couples the eight flip-flops for serial shifting with each clock pulse. When low, the parallel (broadside) data inputs are enabled and synchronous loading occurs on the next clock pulse. During parallel loading, serial data flow is inhibited. Clocking is accomplished on the low-to-high-level edge of the clock pulse through a two-input positive NOR gate permitting one input to be used as a clock-enable or clock-inhibit function. Holding either of the clock inputs high inhibits clocking; holding either low enables the other clock input. This, of course, allows the system clock to be free-running and the register can be stopped on command with the other clock input. The clock inhibit input should be changed to the high level only while the clock input is high. A buffered, direct clear input overrides all other inputs, including the clock, and sets all flip-flops to zero.

FUNCTION TABLE

		IN	PUTS	100	-	INTE	RNAL	OUTPUT	
CLEAR	SHIFT/	CLOCK	01.001	SERIAL	PARALLEL	OUT	PUTS		
LLEAR	LOAD	INHIBIT	LLUCK	SERIAL	AH	QA	QB	αH	
L	×	X	х	×	×	L	L	L	
н	x	L	L	×	×	Q _{A0}	QB0	QH0	
н	L	Ł	1	×	ah	а	b	h	
н	н	L	1	н	×	н	Q _{An}	Q _{Gn}	
н	н	L	1	L	×	L	QAn	QGn	
н	х	н	Ť	x	x	QAO	QB0	QH0	



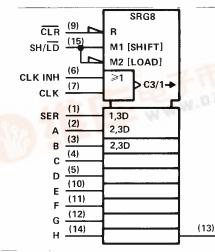
PRODUCTION DATA documents contain information current is of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



logic symbol[†]

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INSTRUMENTS



[†]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

QH

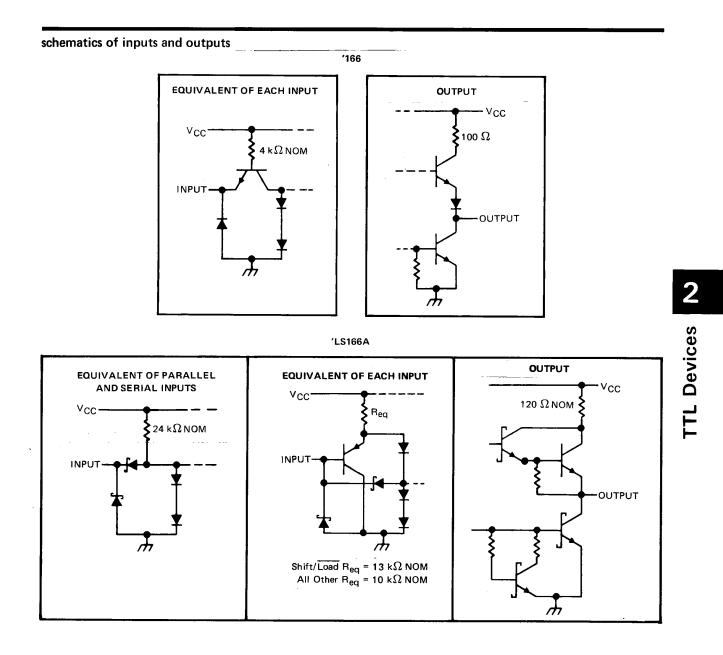
SN54166, SN54LS166A, SN74166, SN74LS166A PARALLEL-LOAD 8-BIT SHIFT REGISTERS

typical clear, shift, load, inhibit, and shift sequences

I SERIAL SHIFT I I I I Ŧ Ŧ -Ļ SERIAL SHIFT CLEAR Ŧ 8 o ō Q CLEAR ۲ ш u. SERIAL INPUT CLOCK INHIBIT SHIFT/LOAD оитрит о_н PARALLEL INPUTS



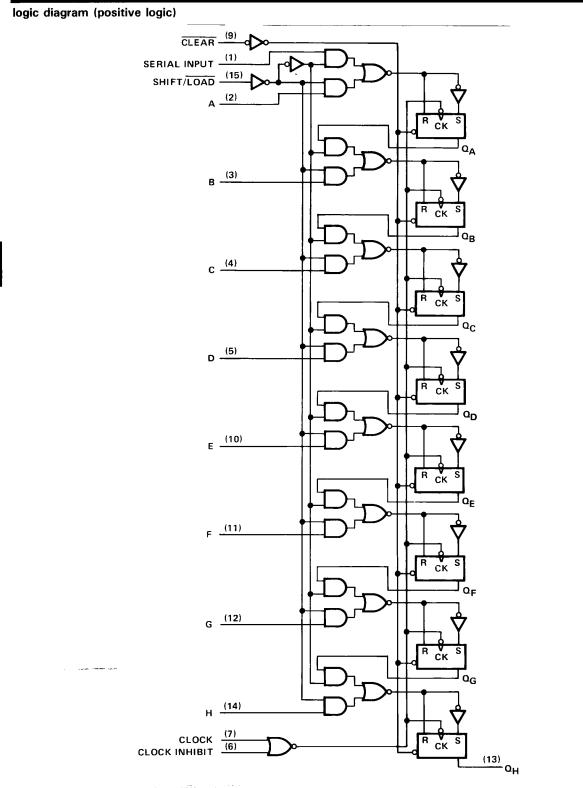
SN54166, SN54LS166A, SN74166, SN74LS166A PARALLEL-LOAD 8-BIT SHIFT REGISTERS



Texas

مهيدة ستحصر الدورات

SN54166, SN54LS166A, SN74166, SN74LS166A **PARALLEL-LOAD 8-BIT SHIFT REGISTERS**



Ч_ср

TEXAS TEXAS

Pin numbers shown are for D, J, N, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	/
Input voltage	/
Operating free-air temperature range: SN54166 (see Note 2)	С
SN74166	С
Storage temperature range \ldots	2

recommended operating conditions

		SN54166			SN74166		
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH			-800			-800	μA
Low-level output current, IOL			16			16	mA
Clock frequency, fclock	0		25	0		25	MHz
Width of clock or clear pulse, tw (see Figure 1)	20			20			ns
Mode-control setup time, t _{su}	30			30			ns
Data setup time, t _{su} (see Figure 1)	20			20			ns
Hold time at any input, th (see Figure 1)	0			0			ns
Operating free-air temperature, T _A (see Note 2)	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		TEST CONDITIONS [†]	5	SN5416	6	s	N7416	6	
	PARAMETER	TEST CONDITIONS	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage		2			2			V
VIL	Low-level input voltage			-	0.8			0.8	V
٧ıĶ	Input clamp voltage	$V_{CC} = MIN, I_I = -12 mA$			-1.5			-1.5	V
v _{он}	High-level output voltage	$V_{CC} = MIN, V_{IH} = 2 V,$ $V_{IL} = 0.8 V, I_{OH} = -800 \mu A$	2.4	3.4		2.4	3.4		v
VOL	Low-level output voltage	$V_{CC} = MIN, V_{IH} = 2V,$ $V_{IL} = 0.8V, I_{OL} = 16 mA$		0.2	0.4		0.2	0.4	v
4	Input current at maximum input voltage	V _{CC} = MAX, V _I = 5.5 V			1	f		1	mA
Чн	High-level input current	V _{CC} = MAX, V _I = 2.4 V	1		40			40	μA
μL	Low-level input current	V _{CC} = MAX, V _I = 0.4 V			-1.6	<u> </u>		-1.6	mA
los	Short-circuit output current§	V _{CC} = MAX	-20		57	-18		-57	mA
1cc	Supply current	V _{CC} = MAX, See Note 3		90	127		90	127	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

Not more than one output should be shorted at a time.

NOTES: 1. Voltage values are with respect to network ground terminal.

2. An SN54166 in the W package operating at free-air temperatures above 113° C requires a heat-sink that provides a thermal resistance from case to free air, $R_{\theta CA}$, of not more than 48° C/W.

3. With all outputs open, 4.5 V applied to the serial input, all other inputs except the clock grounded, ICC is measured after a momentary ground, then 4.5 V, is applied to the clock.

switching characteristics, V_{CC} = 5 V, T_A = 25° C

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
f _{max}	Maximum clock frequency		25	35		MHz
	Propagation delay time, high-to-			35		
^t PHL low-level output from clear	0 15 - F - P - 100 ()		23		ns	
	Propagation delay time, high-to-	CL = 15 pF, RL = 400 Ω, See Figure 1			30	ns
THL	low-level output from clock	See Figure 1		20		
	Propagation delay time, low-to-			47	00	
^t PLH	high-level output from clock			17	26	ns



TTL Devices

SN54LS166A, SN74LS166A PARALLEL·LOAD 8-BIT SHIFT REGISTERS

bsolute maximum ratings over operating free-air temperature range (unless otherwise noted)	
Supply voltage, V _{CC} (see Note 1)	
Operating free-air temperature range: SN54LS166A	125°C
SN74LS166A 0°C t Storage temperature range	

NOTE 1: Voltage values are with respect to network ground terminal.

		SI	SN54LS166A		SN74LS166A				
		MIN		MAX	MIN	ТҮР	MAX	דואט	
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V	
v _{IH}	High-level input voltage	2			2			V	
VIL	Low-level input voltage			0.7	1		0.8	V	
юн	High-level output current			- 0.4			- 0.4	mA	
юг	Low-level output current			4			8	mA	
fclock	Clock frequency	0		25	0		25	MHz	
tw	Width of clear pulse (See Figure 1)	20			20			ns	
tw	Width of clock pulse (See Figure 1)	25			25				
t _{su}	Mode-control setup time	30			30			ns	
t _{su}	Data setup time (See Figure 1)	. 20			20			ns	
^t h	Hold time at any input (See Figure 1 and Note 4)	0			0			ns	
ŤA	Operating free air temperature	- 55		125	0		70	°c	

NOTE 4: The hold time limit of 0 ns applies only if the rise time is less than or equal to 10 ns.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]		SM	SN54LS166A			SN74LS166A			
TANAMETER		TIONS	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT	
VIK	V _{CC} = MIN, I _I = - 18 mA				- 1.5			- 1.5	V	
∨он	$V_{CC} = MIN, V_{IH} = 2 V,$ $I_{OH} = -0.4 \text{ mA}$	V _{IL} = MAX,	2.5	3.4	-	2.7	3.4	=	v	
Vai	$V_{CC} = MIN, V_{IH} = 2 V,$	IOL = 4 mA		0.25	0.4		0.25	0.4	+	
VOL	V _{IL} = MAX	l _{OL} ≃ 8 mA					0.35	0.5	-	
4	V _{CC} = MAX, V _I = 7 V				0.1			0.1	mA	
ЧН	V _{CC} = MAX, V _I = 2.7 V				20			20	μΑ	
μL	V _{CC} = MAX, V _I = 0.4 V				- 0.4		*	- 0.4	mA	
IOSS	V _{CC} = MAX		- 20		- 100	20		- 100	mA	
Icc	V _{CC} = MAX, See Note 5			20	32		20	32	mA	

tFor conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 \pm All typical values are at V_{CC} = 5 V, T_A = 25°C.

\$Not more than one output should be shorted at a time, and duration for short-circuit should not exceed one second.

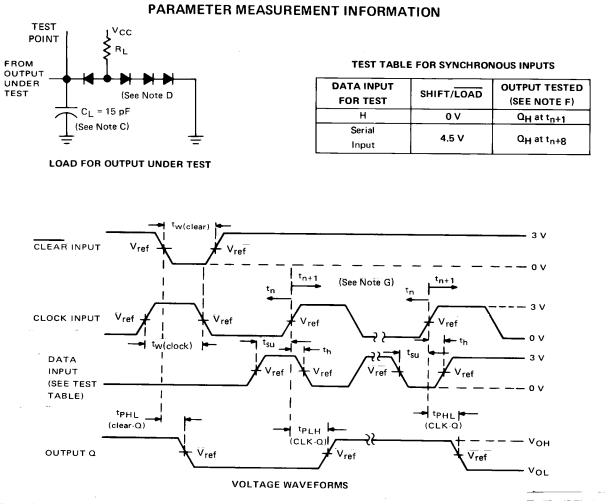
NOTE 5: With all outputs open, 4.5 V applied to the serial input and all other inputs except the clock grounded, I_{CC} is measured after a momentary ground, than 4.5 V, is applied to clock.

switching characteristics, V_{CC} = 5 V, $T_A = 25^{\circ}C$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f _{max} Maximum clock frequency		25	35		MHz
Propagation delay time, high-to-		-			
tPHL low-level output from clear Propagation delay time, high-to-			19	30	ns
	$C_L = 15 \mathrm{pF}, \ R_L = 2 \mathrm{k}\Omega,$				
tPHL low-level output from clock	See Figure 1		14	25	ns
Propagation delay time, low-to-	······································	_			_
^t PLH high-level output from clock		5	11	20	ns

TEXAS INSTRUMEN





NOTE: A. All pulse generators have the following characteristics: $Z_{out} \approx 50\Omega$; for '166, $t_r \leq 7$ ns and $t_f \leq 7$ ns; for 'LS166A, $t_r \leq 15$ ns and $t_f \leq 6$ ns.

- B. The clock pulse has the following characteristics: t_w(clock) ≤ 20 ns and PRR = 1 MHz. The clear pulse has the following characteristics: t_w(clear) ≤ 20 ns and t_{hold} = 0 ns. When testing f_{max}, vary the clock PRR.
- C. CL includes probe and jig capacitance.
- D. All diodes are 1N3064, 1N916, or equivalent.
- E. A clear pulse is applied prior to each test.
- F. Propagation delay times $(t_{PLH} \text{ and } t_{PHL})$ are measured at t_{n+1} . Proper shifting of data is verified at t_{n+8} with a functional test.
- G. $t_n = bit$ time before clocking transition

- $t_{n+1} = bit time after one clocking transition$
- t_{n+8} = bit time after eight clocking transitions
- H. For '166 V_{ref} = 1.5 V; for 'LS166A V_{ref} = 1.3 V.

FIGURE 1



LTL Devices



PACKAGE OPTION ADDENDUM

26-Sep-2005

PACKAGING INFORMATION

Image: Normal Shymology <th>Orderable Device</th> <th>Status ⁽¹⁾</th> <th>Package Type</th> <th>Package Drawing</th> <th>Pins</th> <th>Package Qty</th> <th>Eco Plan ⁽²⁾</th> <th>Lead/Ball Finish</th> <th>MSL Peak Temp ⁽³⁾</th>	Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
5962-9558301QFA ACTIVE CFP W 16 1 TBD Call TI Level-NC-NC-NC 8001701EA ACTIVE CDIP J 16 1 TBD Call TI Level-NC-NC-NC 8001701FA ACTIVE CFP W 16 1 TBD Call TI Level-NC-NC-NC 8001701FA ACTIVE CFP W 16 1 TBD Call TI Level-NC-NC-NC JM38510/3060982A ACTIVE LCCC FK 20 1 TBD Call TI Level-NC-NC-NC JM38510/306098EA ACTIVE CDIP J 16 1 TBD Call TI Level-NC-NC-NC JM38510/306098FA ACTIVE CDIP J 16 1 TBD Call TI Level-NC-NC-NC JM38510/306098FA ACTIVE CDIP J 16 1 TBD Call TI Level-NC-NC-NC SN54166J ACTIVE CDIP J 16 1 TBD Call TI	5962-9558301QEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
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SN74166N3 OBSOLETE PDIP N 16 TBD Call TI Call TI SN74166N3 OBSOLETE PDIP N 16 TBD Call TI Call TI SN7415166AD ACTIVE SOIC D 16 40 Green (RoHS & CU NIPDAU Level-1-260C-UNLIN no Sb/Br) SN74LS166AD ACTIVE SOIC D 16 40 Green (RoHS & CU NIPDAU Level-1-260C-UNLIN no Sb/Br) SN74LS166ADE4 ACTIVE SOIC D 16 40 Green (RoHS & CU NIPDAU Level-1-260C-UNLIN no Sb/Br) SN74LS166ADE4 ACTIVE SOIC D 16 40 Green (RoHS & CU NIPDAU Level-1-260C-UNLIN no Sb/Br) SN74LS166ADR ACTIVE SOIC D 16 2500 Green (RoHS & CU NIPDAU Level-1-260C-UNLIN no Sb/Br) SN74LS166ADR ACTIVE SOIC D 16 2500 Green (RoHS & CU NIPDAU Level-1-260C-UNLIN no Sb/Br) SN74LS166ADRE4 ACTIVE SOIC D 16 2500 Green (RoHS & CU NIPDAU <td>SN74166N</td> <td>OBSOLETE</td> <td>PDIP</td> <td>Ν</td> <td>16</td> <td></td> <td>TBD</td> <td>Call TI</td> <td>Call TI</td>	SN74166N	OBSOLETE	PDIP	Ν	16		TBD	Call TI	Call TI
SN74166N3OBSOLETEPDIPN16TBDCall TICall TISN74LS166ADACTIVESOICD1640Green (RoHS & CU NIPDAULevel-1-260C-UNLIN no Sb/Br)SN74LS166ADACTIVESOICD1640Green (RoHS & CU NIPDAULevel-1-260C-UNLIN no Sb/Br)SN74LS166ADE4ACTIVESOICD1640Green (RoHS & CU NIPDAULevel-1-260C-UNLIN no Sb/Br)SN74LS166ADE4ACTIVESOICD1640Green (RoHS & CU NIPDAULevel-1-260C-UNLIN no Sb/Br)SN74LS166ADE4ACTIVESOICD1640Green (RoHS & CU NIPDAULevel-1-260C-UNLIN no Sb/Br)SN74LS166ADRACTIVESOICD162500Green (RoHS & CU NIPDAULevel-1-260C-UNLIN no Sb/Br)SN74LS166ADRACTIVESOICD162500Green (RoHS & CU NIPDAULevel-1-260C-UNLIN no Sb/Br)SN74LS166ADRE4ACTIVESOICD162500Green (RoHS & CU NIPDAULevel-1-260C-UNLIN no Sb/Br)SN74LS166ADRE4ACTIVESOICD162500Green (RoHS & CU NIPDAULevel-1-260C-UNLIN no Sb/Br)SN74LS166AJOBSOLETECDIPJ16TBDCall TICall TISN74LS166AJOBSOLETECDIPJ16TBDCall TICall TISN74LS166ANACTIVEPDIPN1625Pb-FreeCU NIPDAULevel-NC-NC-NC 	SN74166N	OBSOLETE	PDIP	Ν	16		TBD	Call TI	Call TI
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N74LS166ADE4ACTIVESOICD1640Green (RoHS & CU NIPDAULevel-1-260C-UNLIN no Sb/Br)SN74LS166ADRACTIVESOICD162500Green (RoHS & CU NIPDAULevel-1-260C-UNLIN no Sb/Br)SN74LS166ADRACTIVESOICD162500Green (RoHS & CU NIPDAULevel-1-260C-UNLIN no Sb/Br)SN74LS166ADRE4ACTIVESOICD162500Green (RoHS & CU NIPDAULevel-1-260C-UNLIN no Sb/Br)SN74LS166AJOBSOLETECDIPJ16TBDCall TICall TISN74LS166ANACTIVEPDIPJ16TBDCall TICall TISN74LS166ANACTIVEPDIPN1625Pb-Free (RoHS)CU NIPDAULevel-NC-NC-NC (ROHS)SN74LS166ANACTIVEPDIPN1625Pb-Free (CU NIPDAULevel-NC-NC-NC (ROHS)SN74LS166AN3OBSOLETEPDIPN16TBDCall TICall TISN74LS166AN3OBSOLETEPDIPN16TBDCall TICall TI	SN74LS166AD	ACTIVE	SOIC	D	16	40		CU NIPDAU	Level-1-260C-UNLIM
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no Sb/Br)SN74LS166AJOBSOLETECDIPJ16TBDCall TICall TISN74LS166AJOBSOLETECDIPJ16TBDCall TICall TISN74LS166ANACTIVEPDIPN1625Pb-Free (RoHS)CU NIPDAULevel-NC-NC-NCSN74LS166ANACTIVEPDIPN1625Pb-Free (RoHS)CU NIPDAULevel-NC-NC-NCSN74LS166AN3OBSOLETEPDIPN16TBDCall TICall TI	SN74LS166ADRE4	ACTIVE	SOIC	D	16	2500		CU NIPDAU	Level-1-260C-UNLIM
SN74LS166AJOBSOLETECDIPJ16TBDCall TICall TISN74LS166ANACTIVEPDIPN1625Pb-Free (RoHS)CU NIPDAULevel-NC-NC-NCSN74LS166ANACTIVEPDIPN1625Pb-Free (RoHS)CU NIPDAULevel-NC-NC-NCSN74LS166AN3OBSOLETEPDIPN16TBDCall TICall TI	SN74LS166ADRE4	ACTIVE	SOIC	D	16	2500		CU NIPDAU	Level-1-260C-UNLIM
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(RoHS) SN74LS166AN ACTIVE PDIP N 16 25 Pb-Free (RoHS) CU NIPDAU Level-NC-NC-NC (RoHS) SN74LS166AN3 OBSOLETE PDIP N 16 TBD Call TI Call TI	SN74LS166AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
(RoHS) SN74LS166AN3 OBSOLETE PDIP N 16 TBD Call TI Call TI	SN74LS166AN	ACTIVE	PDIP	Ν	16	25		CU NIPDAU	Level-NC-NC-NC
	SN74LS166AN	ACTIVE	PDIP	Ν	16	25		CU NIPDAU	Level-NC-NC-NC
SN74LS166AN3 OBSOLETE PDIP N 16 TBD Call TI Call TI	SN74LS166AN3	OBSOLETE	PDIP	Ν	16		TBD	Call TI	Call TI
	SN74LS166AN3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI



PACKAGE OPTION ADDENDUM

26-Sep-2005

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74LS166ANSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS166ANSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS166ANSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS166ANSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SNJ54166J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54166J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54166W	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54166W	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS166AFK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS166AFK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS166AJ	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS166AJ	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS166AW	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS166AW	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

J (R-GDIP-T**) 14 LEADS SHOWN

PINS ** 14 16 20 18 DIM 0.300 0.300 0.300 0.300 В Α (7,62) (7,62) (7,62) (7,62) BSC BSC BSC BSC 14 8 0.785 .840 0.960 1.060 B MAX (19, 94)(21, 34)(24, 38)(26, 92)B MIN С 0.300 0.300 0.310 0.300 C MAX (7, 62)(7, 62)(7, 87)(7, 62)7 0.245 0.245 0.220 0.245 0.065 (1,65) C MIN (6, 22)(6,22) (5, 59)(6,22) 0.045 (1,14) 0.060 (1,52) ← 0.005 (0,13) MIN Α 0.015 (0,38) 0.200 (5,08) MAX Seating Plane 0.130 (3,30) MIN 0.026 (0,66) 0.014 (0,36) 0'-15' 0.100 (2,54) 0.014 (0,36) 0.008 (0,20) 4040083/F 03/03

CERAMIC DUAL IN-LINE PACKAGE

NOTES: A. All linear dimensions are in inches (millimeters).

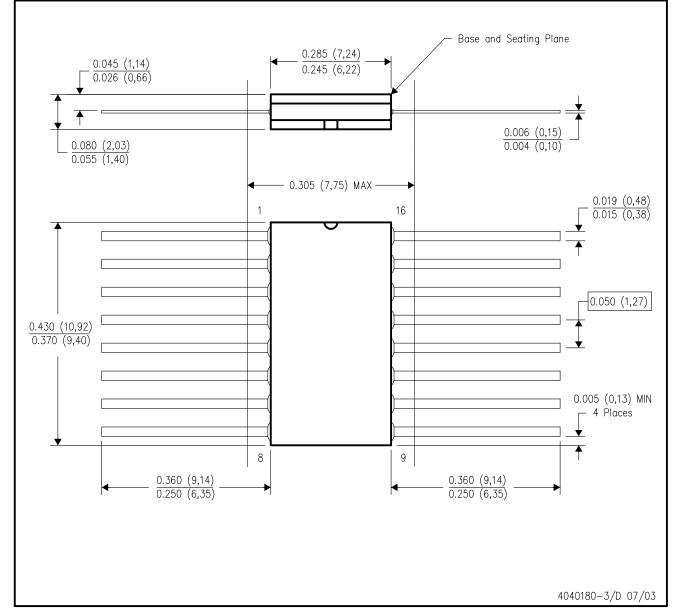
B. This drawing is subject to change without notice.

- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.

E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



NOTES:

: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F16 and JEDEC MO-092AC

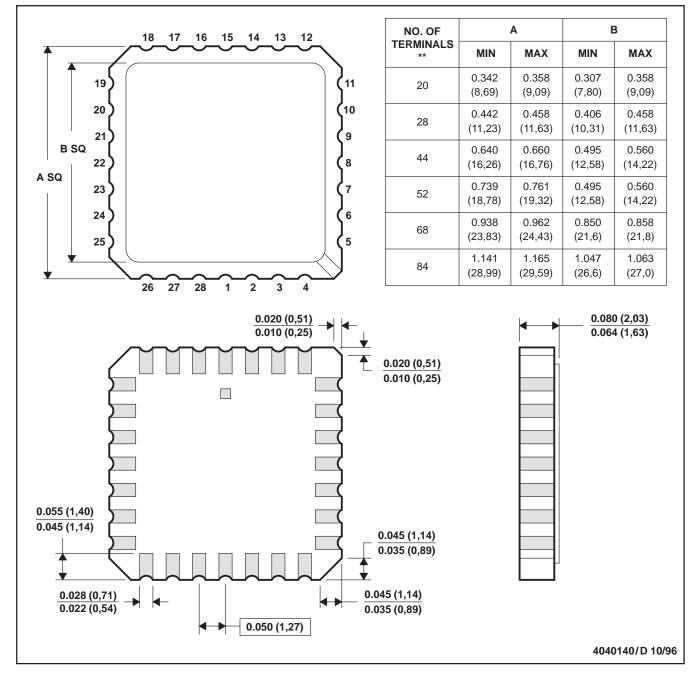


MECHANICAL DATA

MLCC006B - OCTOBER 1996

LEADLESS CERAMIC CHIP CARRIER

FK (S-CQCC-N**) 28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

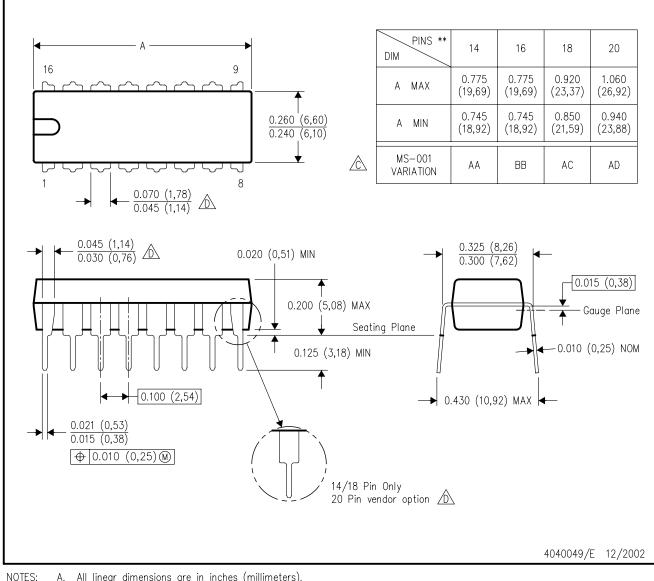
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

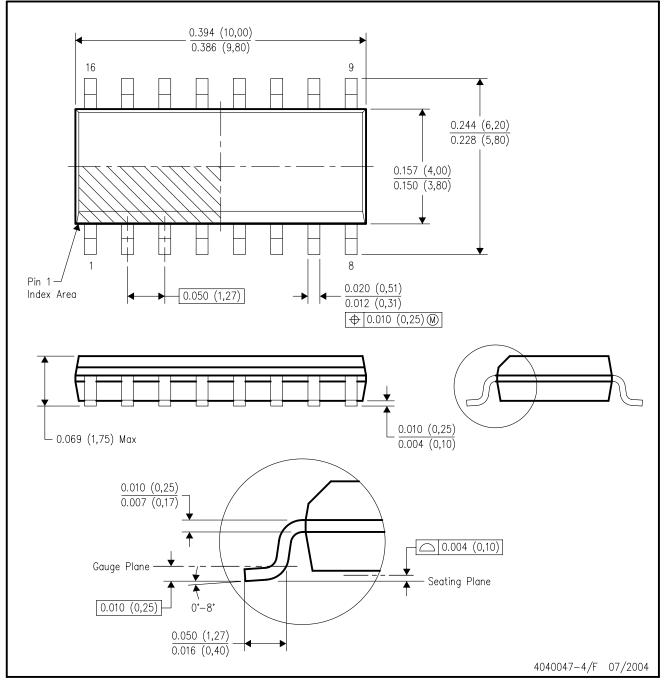
🖄 Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



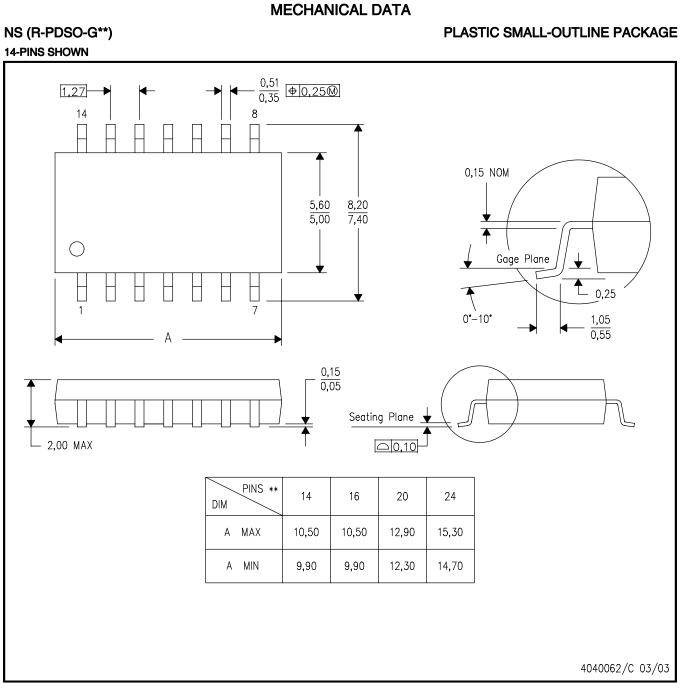
NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012 variation AC.





NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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